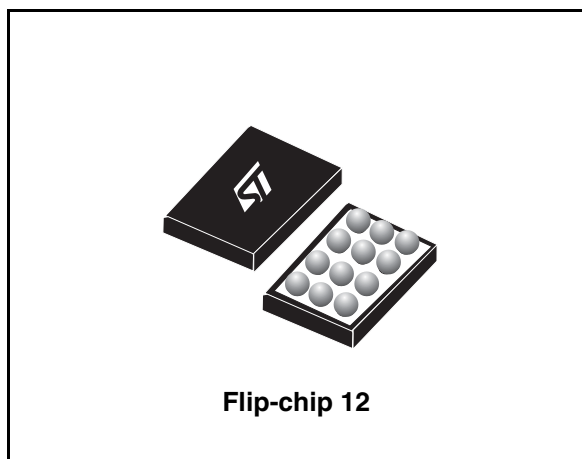


### Features

- Distortion-free negative signal throughput down to  $V_{CC} - 5.5\text{ V}$
- Wide operating voltage range:  
 $V_{CC}(\text{opr}) = 1.65\text{ to }4.5\text{ V}$  single supply
- Ultra low power dissipation:  
 $I_{CC} = 0.2\text{ }\mu\text{A}$  (max.) at  $T_A = 85\text{ }^\circ\text{C}$
- Low ON resistance:  
 $R_{ON} = 0.5\text{ }\Omega$  (max.  $T_A = 25\text{ }^\circ\text{C}$ ) at  $V_{CC} = 3.6\text{ V}$
- 4.3 V tolerant and 1.8 V compatible threshold on digital control input at  $V_{CC} = 1.65\text{ V to }4.5\text{ V}$
- Latch-up performance exceeds 300 mA (JESD 17)
- ESD performance:
  - 2000-V human-body model (IEC61340-3-1:2002 level 2)
  - 200-V machine model (IEC61340-3-2 level M2)
  - 1000-V charge device model (JESD22-C101-A level III)



### Description

The STG5678 is a high-speed CMOS low voltage dual analog SPDT (single pole dual throw) switch or 2:1 multiplexer/de-multiplexer switch fabricated in silicon gate CMOS technology. It is designed to operate from 1.65 to 4.5 V.

The device is capable of handling signals with negative voltages from  $V_{CC} - 5.5\text{ V}$  to  $V_{CC}$  without any distortion.

Additional key features are fast switching speed, break-before-make delay time and ultra low power consumption. All inputs and outputs are equipped with protection circuits against static discharge, giving them ESD immunity and transient excess voltage.

**Table 1. Device summary**

Order code	Package	Packaging
STG5678BJR	Flip-chip 12	Tape and reel
STG5678CJR	Flip-chip 12 (with back side coating)	Tape and reel

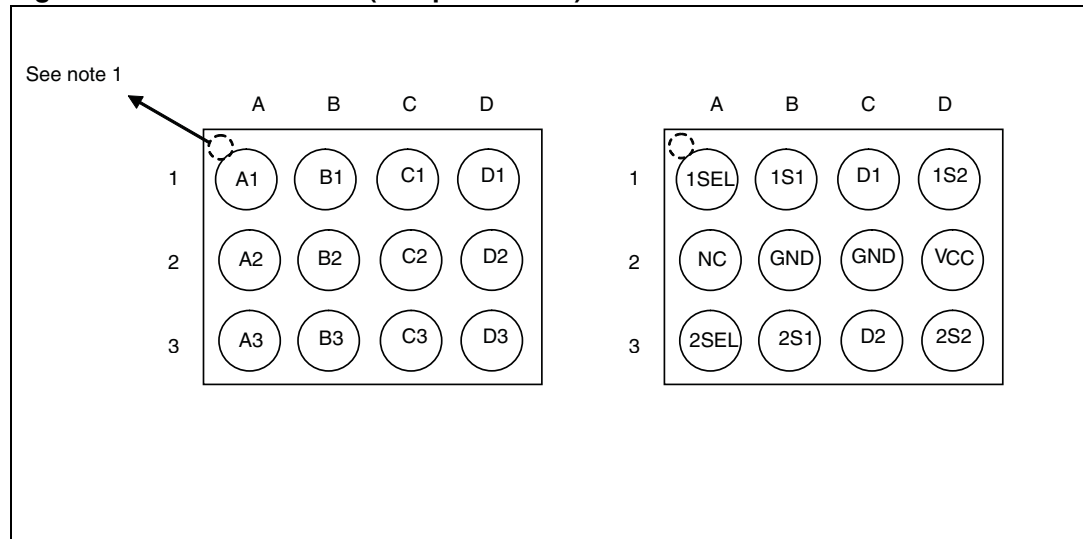
# Contents

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# 1 Pin settings

## 1.1 Pin connection

**Figure 1. Pin connection (bump side view)**



1. Note 1: bump A1 is distinguished by a circular dot on the top-side. There is no circular dot on the bump-side.

## 1.2 Pin description

**Table 2. Pin assignment**

Pin number	Symbol	Name and function
A1	1SEL	Selection control for switch 1
A2	NC	No connection
A3	2SEL	Selection control for switch 2
B1	1S1	Independent channel for switch 1
B2	GND	Ground (0 V)
B3	2S1	Independent channel for switch 2
C1	D1	Common channel for switch 1
C2	GND	Ground (0 V)
C3	D2	Common channel for switch 2
D1	1S2	Independent channel for switch 1
D2	V <sub>CC</sub>	Positive supply voltage
D3	2S2	Independent channel for switch 2



### 3 Maximum rating

Stressing the device above the rating listed in the “absolute maximum ratings” table may cause permanent damage to the device. These are stress ratings only and operation of the device at these or any other conditions above those indicated in the operating sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

**Table 4. Absolute maximum ratings**

Symbol	Parameter	Value	Unit
$V_{CC}$	Supply voltage	-0.5 to 5.5	V
$V_I$	DC input voltage	- ( $V_{CC} - 6.0$ ) to $V_{CC} + 0.5$	V
$V_{IC}$	DC control input voltage	-0.5 to 5.5	V
$V_O$	DC output voltage	- ( $V_{CC} - 6.0$ V) to $V_{CC} + 0.5$	V
$I_{IKC}$	DC input diode current on control pin ( $V_{SEL} < 0$ V)	-50	mA
$I_{IK}$	DC input diode current ( $V_{IN} < 0$ V)	$\pm 50$	mA
$I_{OK}$	DC output diode current	$\pm 20$	mA
$I_O$	DC output current	$\pm 150$	mA
$I_{OP}$	DC output current peak (pulse at 1ms, 10% duty cycle)	$\pm 400$	mA
$I_{CC}$ or $I_{GND}$	DC $V_{CC}$ or ground current	$\pm 100$	mA
$P_D$	Power dissipation at $T_A = 70^\circ\text{C}$ <sup>(1)</sup>	1120	mW
$T_{stg}$	Storage temperature	-65 to 150	$^\circ\text{C}$
$T_L$	Lead temperature (10 sec)	300	$^\circ\text{C}$

1. Derate above 70  $^\circ\text{C}$  by 18.5 mW/ $^\circ\text{C}$

### 3.1 Recommended operating conditions

**Table 5. Recommended operating conditions**

Symbol	Parameter		Value	Unit
$V_{CC}$	Supply voltage		1.65 to 4.5	V
$V_I$	Input voltage		$V_{CC} - 5.5$ to $V_{CC}$	V
$V_{IC}$	Control input voltage		0 to 4.5	V
$V_O$	Output voltage		$V_{CC} - 5.5$ to $V_{CC}$	V
$T_{op}$	Operating temperature		-40 to 85	°C
dt/dv	Input rise and fall time control input	$V_{CC} = 1.65$ to $2.7$ V	0 to 20	ns/V
		$V_{CC} = 3.0$ to $4.5$ V	0 to 10	

## 4 Electrical characteristics

Table 6. DC specifications

Symbol	Parameter	Test conditions		Value					Unit
		V <sub>CC</sub> (V)		T <sub>A</sub> = 25 °C			-40 to 85 °C		
				Min	Typ	Max	Min	Max	
V <sub>IH</sub>	High level input voltage	1.65 – 1.95		0.9	–	–	0.9	–	V
		2.25 – 2.7		0.9	–	–	0.9	–	
		3.0 – 4.3		1.0	–	–	1.0	–	
		4.5		1.1	–	–	1.1	–	
V <sub>IL</sub>	Low level input voltage	1.65 – 1.95		–	–	0.6	–	0.6	V
		2.25 – 2.7		–	–	0.6	–	0.6	
		3.0 – 4.3		–	–	0.7	–	0.7	
		4.5		–	–	0.7	–	0.7	
R <sub>ON</sub>	Switch ON resistance	1.8	V <sub>S</sub> = V <sub>CC</sub> – 5.5 V to V <sub>CC</sub> ; I <sub>S</sub> = 100 mA	–	3.80	4.60	–	7.0	Ω
		2.7		–	0.77	0.90	–	1.2	
		3.0		–	0.64	0.80	–	1.0	
		3.6		–	0.51	0.65	–	1.0	
ΔR <sub>ON</sub>	ON resistance match between channels <sup>(1)</sup>	1.8	V <sub>S</sub> at R <sub>ON</sub> max I <sub>S</sub> = 100 mA	–	50	–	–	500	mΩ
		2.7		–	20	–	–	500	
		3.0		–	15	–	–	500	
		3.6		–	15	–	–	500	
R <sub>FLAT</sub>	ON resistance flatness <sup>(2)</sup>	1.8	V <sub>S</sub> = V <sub>CC</sub> – 5.5 V to V <sub>CC</sub> ; I <sub>S</sub> = 100 mA	–	3.5	–	–	6.6	Ω
		2.7		–	0.50	–	–	0.8	
		3.0		–	0.40	–	–	0.6	
		3.6		–	0.25	–	–	0.5	
I <sub>OFF</sub>	Sn OFF state leakage current	3.6	V <sub>S</sub> = -1.2 to 3.6 V V <sub>D</sub> = 3.6 to -1.2 V	–	-0.55	–	-2	1	μA
I <sub>ON</sub>	Sn ON state leakage current	3.6	V <sub>S</sub> = -1.2 to 3.6 V V <sub>D</sub> = open	–	-0.55	–	-2	1	μA

Table 6. DC specifications (continued)

Symbol	Parameter	Test conditions		Value					Unit
		V <sub>CC</sub> (V)		T <sub>A</sub> = 25 °C			-40 to 85 °C		
				Min	Typ	Max	Min	Max	
I <sub>D</sub>	D ON state leakage current	3.6	V <sub>S</sub> = open V <sub>D</sub> = -1.2 V to 3.6 V	–	0.55	–	-2	1	μA
I <sub>IH</sub> , I <sub>IL</sub>	SEL leakage current	3.6	V <sub>SEL</sub> = 3.6 V or GND	-0.1		0.1	-1	1	μA
I <sub>CCLV</sub>	Quiescent supply current low voltage driving	3.6	V <sub>1SEL</sub> , V <sub>2SEL</sub> = 1.80 V	–	7	–	–	10	μA
I <sub>CC</sub>	Quiescent supply current <sup>(3)</sup>	2.5	V <sub>1SEL</sub> = V <sub>2SEL</sub> = V <sub>CC</sub>	–	5.6	–	–	10	μA
		3.6		–	8	–	–	16	
		1.65 –4.5	V <sub>1SEL</sub> = V <sub>2SEL</sub> = GND	–	0.05	–	–	0.1	

1. Note 1:  $\Delta R_{ON} = R_{ON(max)} - R_{ON(min)}$

2. Flatness is defined as the difference between the maximum and minimum value of on-resistance as measured over the specified analog signal ranges.

3. When V<sub>1SEL</sub> and V<sub>2SEL</sub> is both low, the I<sub>CC</sub> consumption will reduce to less than 0.1 μA (max)



Table 7. AC electrical characteristics ( $C_L = 35 \text{ pF}$ ,  $R_L = 50 \Omega$ ,  $t_r = t_f \leq 5 \text{ ns}$ )

Symbol	Parameter	Test conditions		Value					Unit
		V <sub>CC</sub> (V)		T <sub>A</sub> = 25°C			-40 to 85°C		
				Min	Typ	Max	Min	Max	
t <sub>PLH</sub> , t <sub>PHL</sub>	Propagation delay	1.65 – 1.95		–	0.45	–	–	–	ns
		2.3 – 2.7		–	0.40	–	–	–	
		3.0 – 3.3		–	0.30	–	–	–	
		3.6		–	0.25	–	–	–	
t <sub>ON</sub>	Turn ON time	1.65 – 1.95	V <sub>S</sub> = 0.8 V	–	220	265	–	–	ns
		2.3 – 2.7	V <sub>S</sub> = 1.5 V	–	140	175	–	–	
		3.0 – 3.3		–	110	135	–	–	
		3.6		–	105	130	–	–	
t <sub>OFF</sub>	Turn OFF time	1.65 – 1.95	V <sub>S</sub> = 0.8	–	120	150	–	–	ns
		2.3 – 2.7	V <sub>S</sub> = 1.5 V	–	77	92	–	–	
		3.0 – 3.3		–	77	92	–	–	
		3.6		–	77	92	–	–	
t <sub>D</sub>	Break-before-make time delay	1.65 – 1.95	C <sub>L</sub> = 35 pF R <sub>L</sub> = 50 Ω V <sub>S</sub> = V <sub>CC</sub> /2	–	120	–	–	–	ns
		2.3 – 2.7		–	66	–	–	–	
		3.0 – 3.3		–	40	–	–	–	
		3.6		–	30	–	–	–	
Q	Charge injection	1.65 – 1.95	C <sub>L</sub> = 100 pF V <sub>GEN</sub> = 0 V	–	55	–	–	–	pC
		2.3 – 2.7		–	76	–	–	–	
		3.0 – 3.3		–	94	–	–	–	
		3.6		–	126	–	–	–	

Table 8. Analog switch characteristics ( $C_L = 5 \text{ pF}$ ,  $R_L = 50 \Omega$ )

Symbol	Parameter	Test conditions		Value					Unit
		V <sub>CC</sub> (V)		T <sub>A</sub> = 25 °C			-40 to 85 °C		
				Min	Typ	Max	Min	Max	
O <sub>IRR</sub>	OFF isolation <sup>(1)</sup>	2.7 – 3.6	V <sub>S</sub> = 1 V <sub>RMS</sub> , f = 100 kHz	–	-86	–	–	–	dB
			V <sub>S</sub> = 1 V <sub>RMS</sub> , f = 1 MHz	–	-70	–	–	–	
			V <sub>S</sub> = 1 V <sub>RMS</sub> , f = 5 MHz	–	-54	–	–	–	
X <sub>talk</sub>	Crosstalk <sup>(2)</sup>	2.7 – 3.6	V <sub>S</sub> = 1 V <sub>RMS</sub> , f = 100 kHz	–	-96	–	–	–	dB
			V <sub>S</sub> = 1 V <sub>RMS</sub> , f = 1 MHz	–	-87	–	–	–	
			V <sub>S</sub> = 1 V <sub>RMS</sub> , f = 5 MHz	–	-74	–	–	–	
T <sub>HD</sub>	Total harmonic distortion	2.7 – 3.6	R <sub>L</sub> = 32 Ω V <sub>IN</sub> = 0.5 V <sub>PP</sub> DC bias = 0 f = 20 Hz to 20 kHz	–	0.01	–	–	–	%
BW	-3dB bandwidth	2.7 – 3.6	R <sub>L</sub> = 50 Ω Signal = 0 dBm	–	30	–	–	–	MHz
C <sub>SEL</sub>	Control pin input capacitance	3.3	f = 1 MHz	–	12	–	–	–	pF
C <sub>Sn(OFF)</sub>	OFF Sn port capacitance	3.3	f = 1 MHz	–	120	–	–	–	pF
C <sub>D</sub>	D port capacitance when switch is enabled	3.3	f = 1 MHz	–	290	–	–	–	pF

1. Off isolation =  $20\text{Log}_{10} (V_D/V_S)$ ,  $V_D$  = output.  $V_S$  = input to off switch.

2. Crosstalk values are measured between two switches.

5 Test circuit

Figure 4. ON resistance

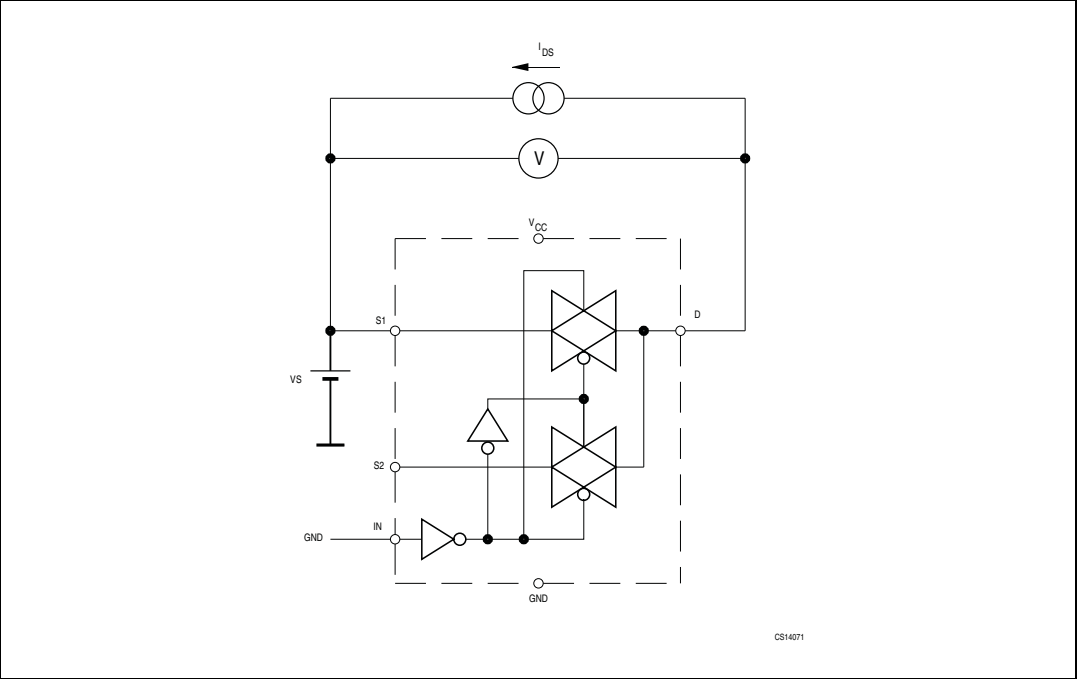


Figure 5. OFF leakage

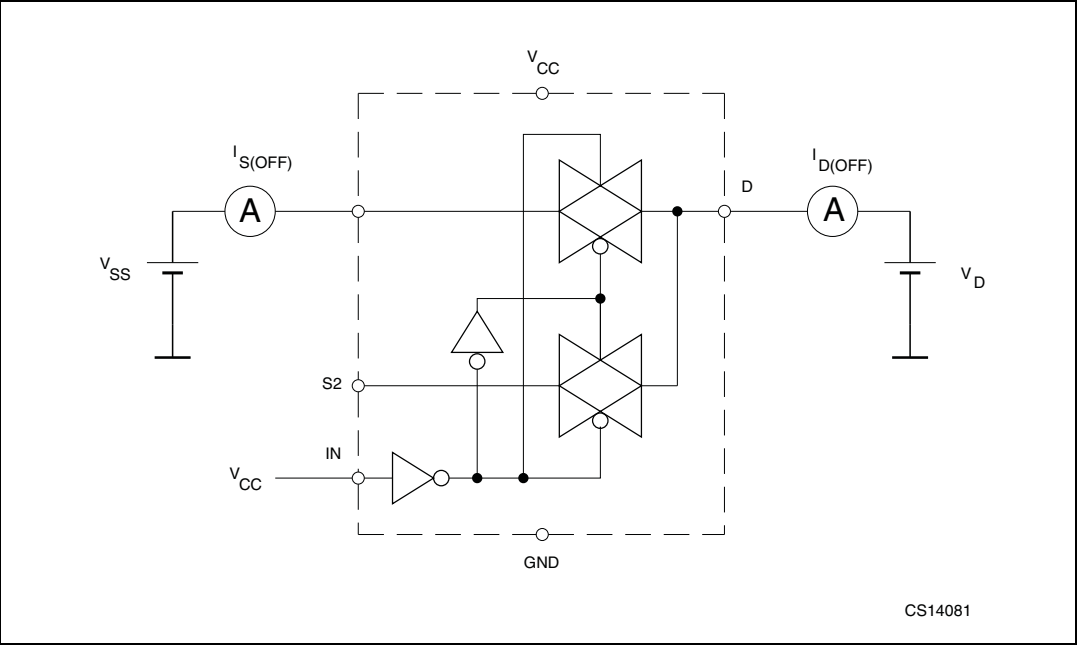


Figure 6. OFF isolation

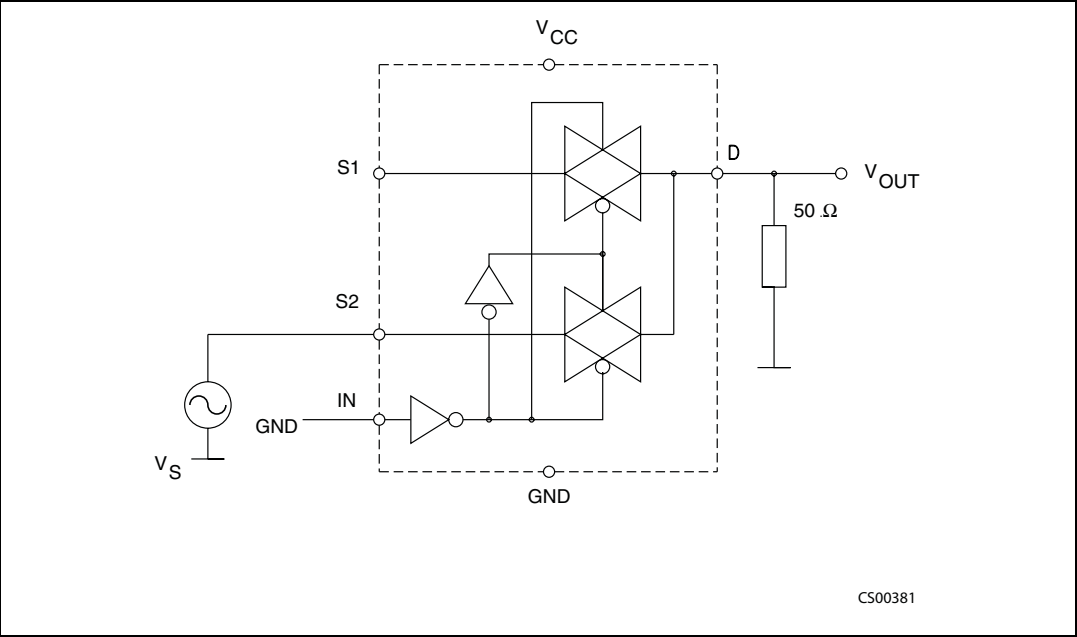
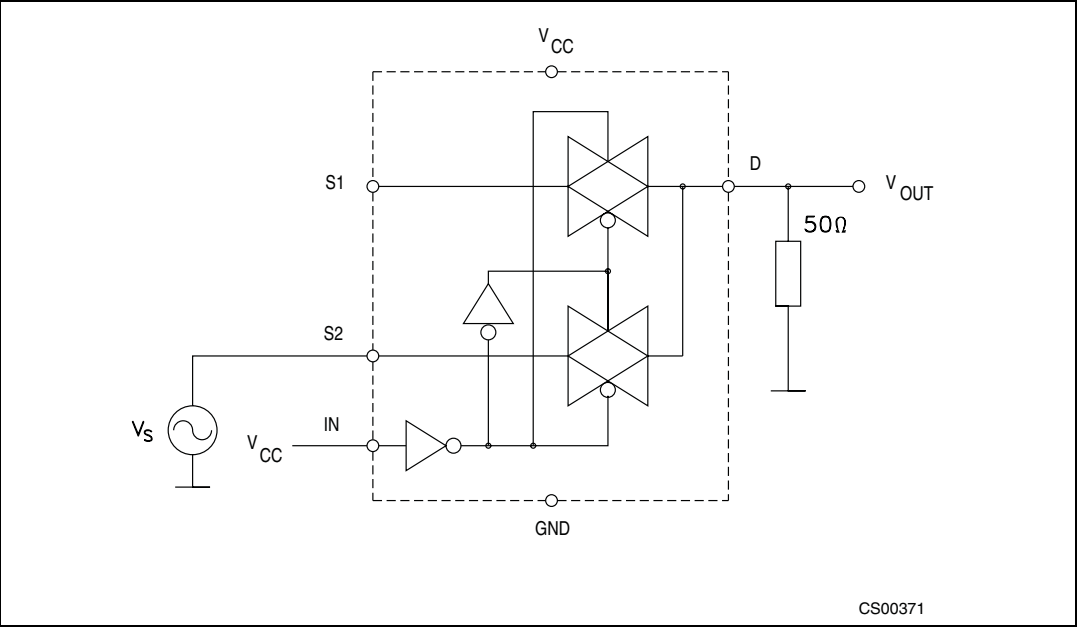
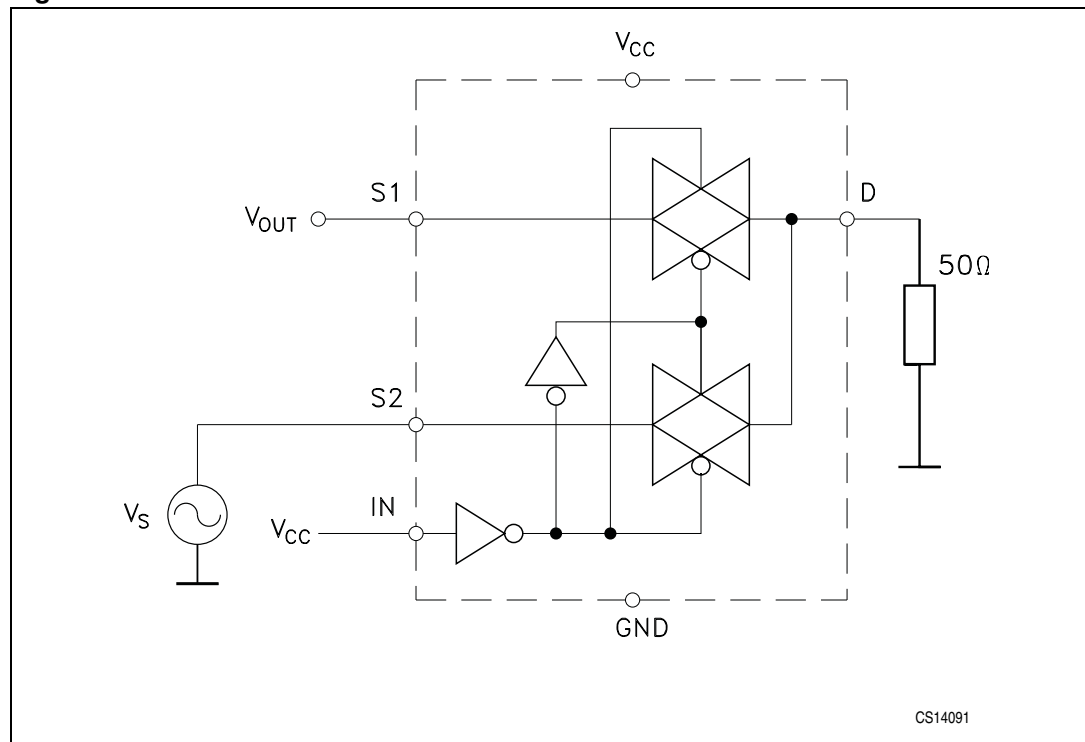
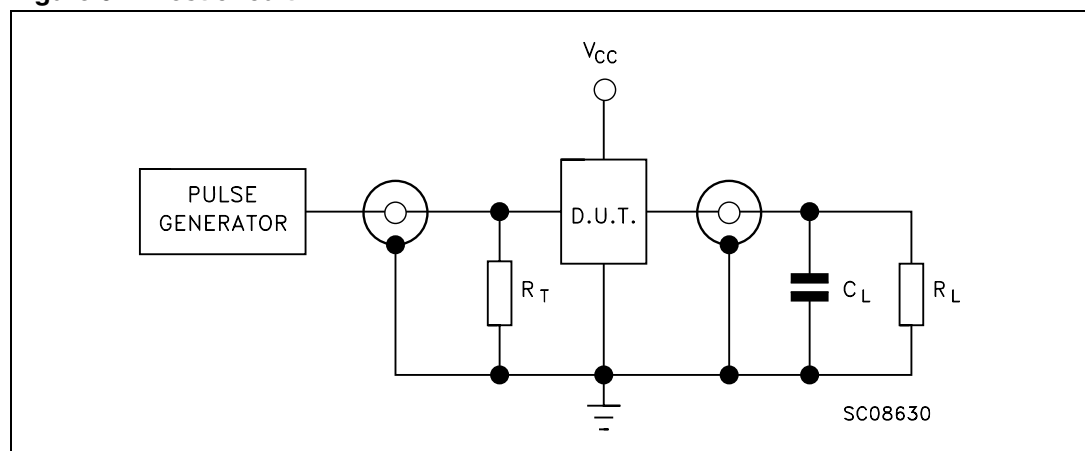


Figure 7. Bandwidth



**Figure 8. Channel-to-channel crosstalk****Figure 9. Test circuit**

2.  $C_L = 5/35$  pF or equivalent (includes jig and probe capacitance)
3.  $R_L = 50\Omega$  or equivalent
4.  $R_T = Z_{OUT}$  of pulse generator (typically  $50\Omega$ )

Figure 10. Break-before-make time delay

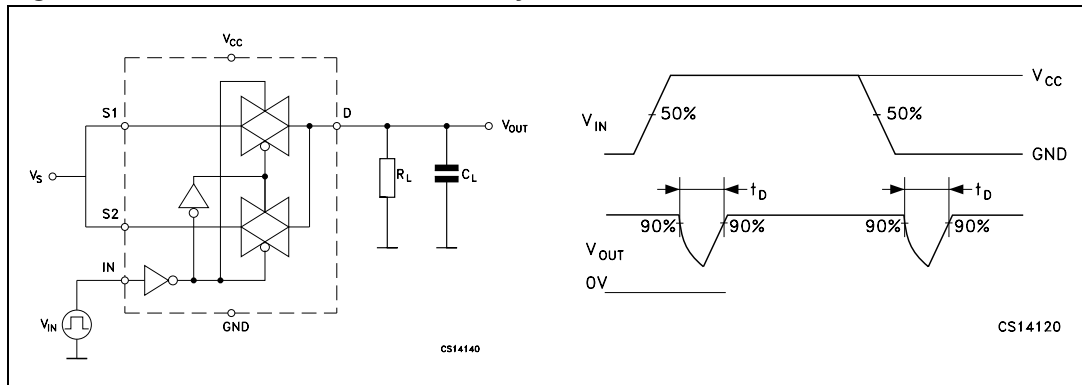
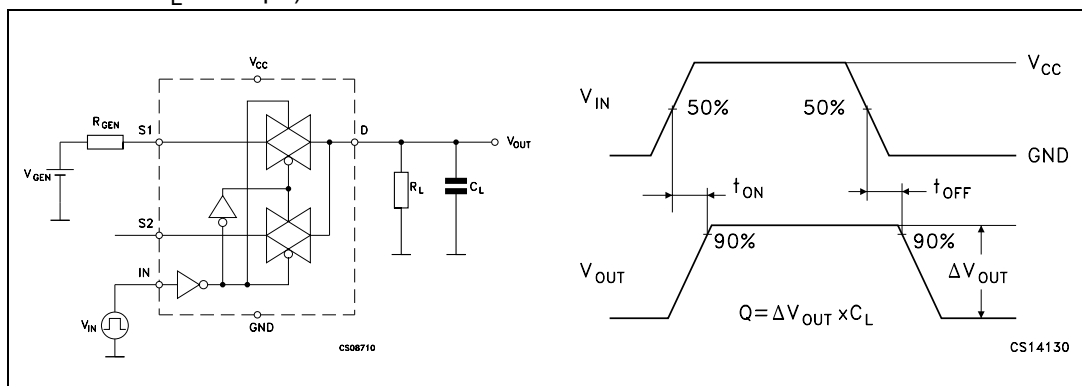
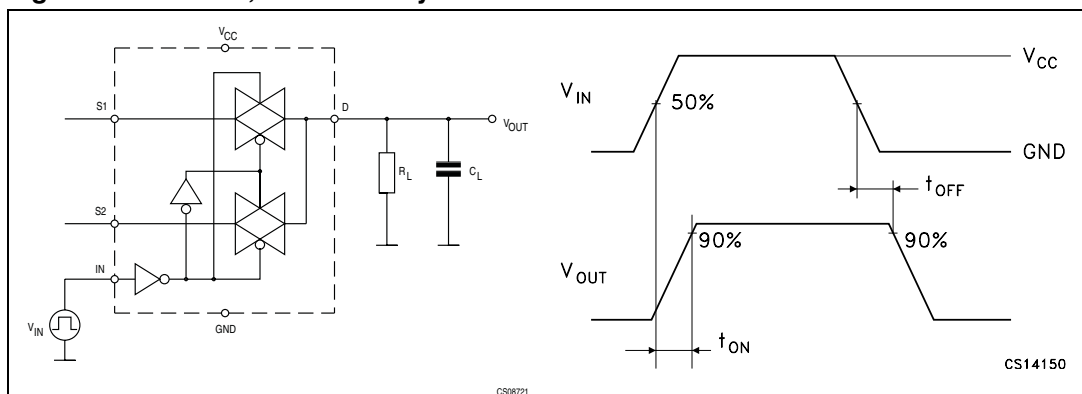
Figure 11. Switching time and charge injection ( $V_{GEN} = 0\text{ V}$ ,  $R_{GEN} = 0\ \Omega$ ,  $R_L = 1\text{ M}\Omega$ ,  $C_L = 100\text{ pF}$ )

Figure 12. Turn on, turn off delay time



## 6 Application hint

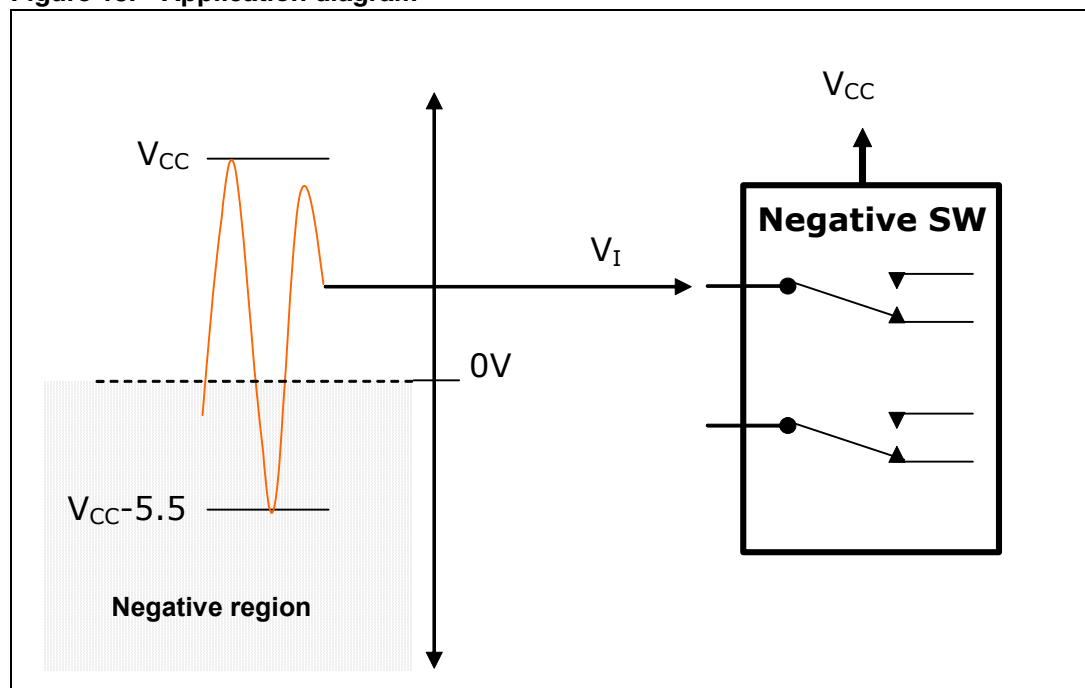
### 6.1 Input signal dynamic range

The STG5678 negative analog switch allows input signals that fall below 0 V to pass through the switch without signal distortion. The input signal dynamic range  $V_I$  consists of a positive-region and a negative-region.

The positive-region is limited by the level of  $V_{CC}$ . The negative-region is limited by the difference between  $V_{CC}$  and 5.5 V. The effect of this is that, the higher the  $V_{CC}$ , the smaller the operating range in the negative region.

For example, if  $V_{CC} = 3.6$  V, the input signal dynamic range is from -1.9 V to 3.6 V.

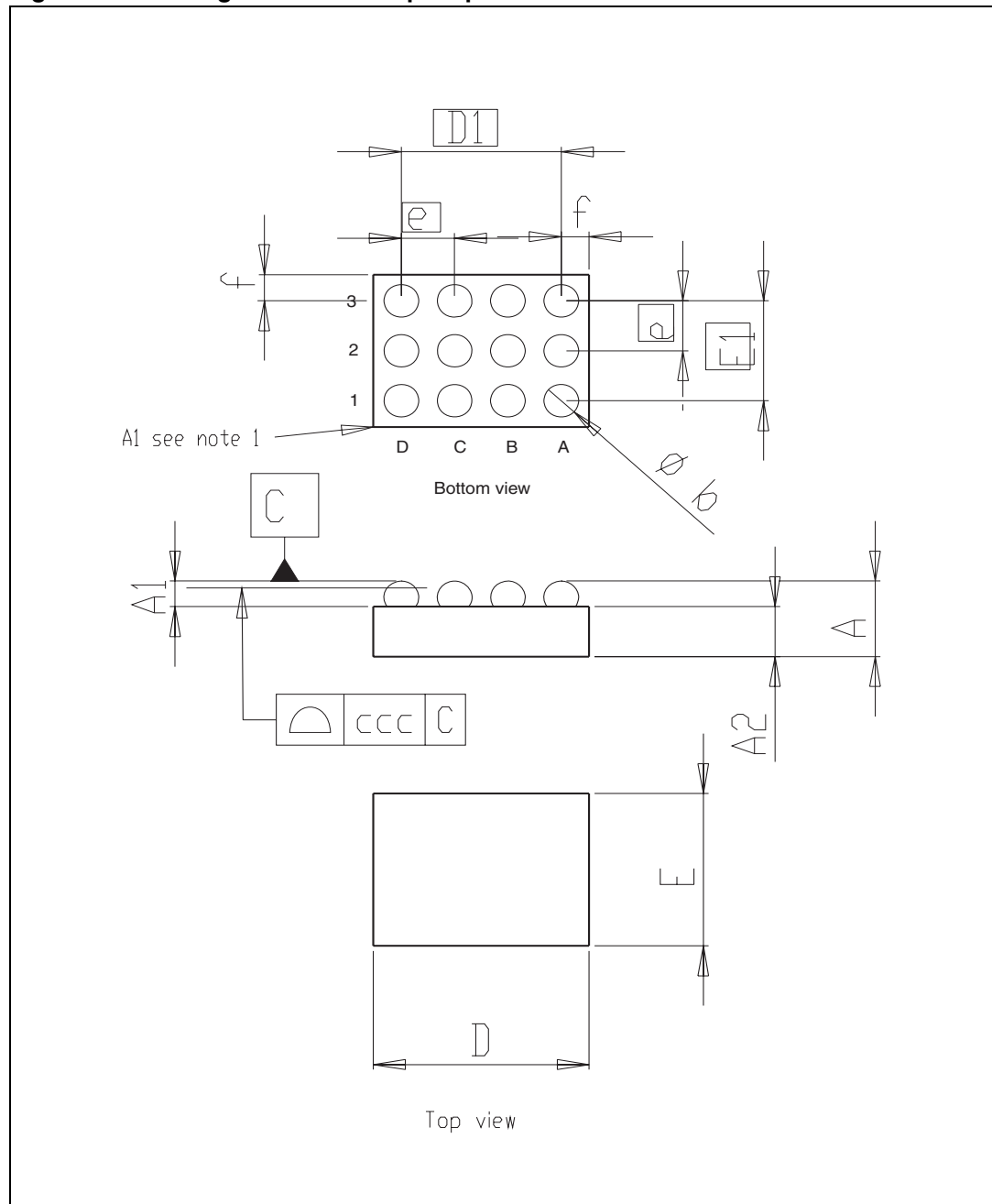
**Figure 13. Application diagram**



## 7 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK® is an ST trademark.

**Figure 14. Package outline for Flip-chip 12**





**Table 9. Mechanical data for Flip-chip 12**

Symbol	Millimeters		
	Min	Typ	Max
A	0.55	0.605	0.66
A1	0.17	0.205	0.24
A2	0.38	0.4	0.42
b	0.215	0.255	0.295
D	1.568	1.598	1.628
D1	–	1.2	–
E	1.168	1.198	1.228
E1	–	0.8	–
e	0.36	0.4	0.44
f	0.189	0.199	0.209
ccc	–	0.05	–

**Figure 15. Footprint recommendation**

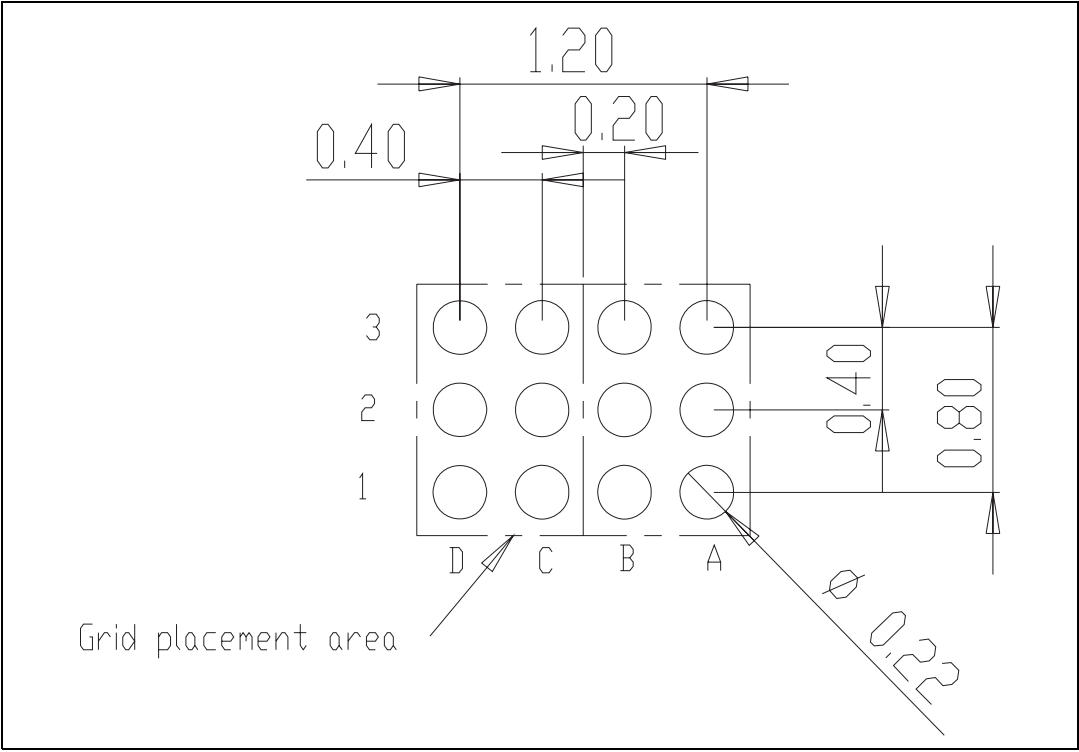


Figure 16. Package outline for Flip-chip 12 with back side coating

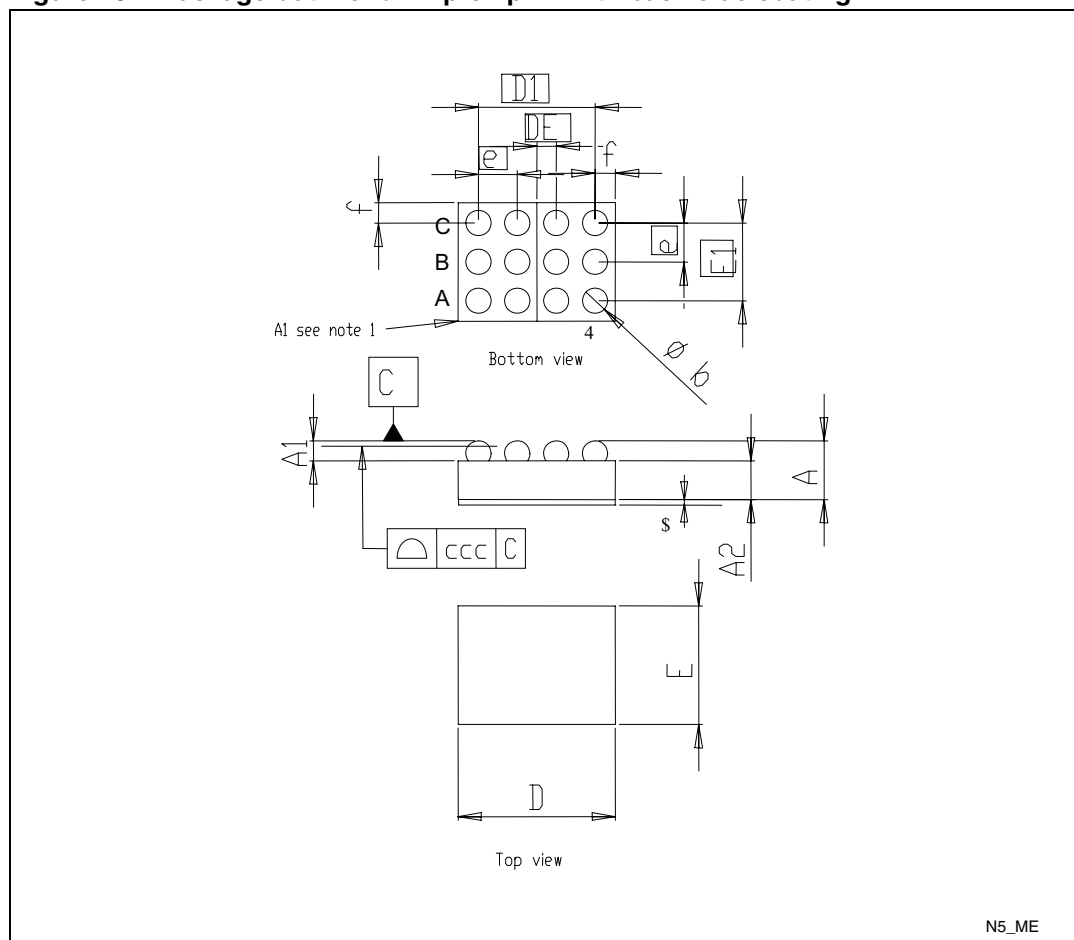


Table 10. Mechanical data for Flip-chip 12 with back side coating

Symbol	Millimeters		
	Min	Typ	Max
A	0.595	0.65	0.705
A1	0.165	0.20	0.235
A2	0.38	0.4	0.42
b	0.215	0.255	0.295
D	1.568	1.598	1.628
D1	—	1.2	—
E	1.168	1.198	1.228
E1	—	0.8	—
e	0.36	0.4	0.44
f	0.189	0.199	0.209
ccc	—	0.05	—

Figure 17. Footprint recommendation

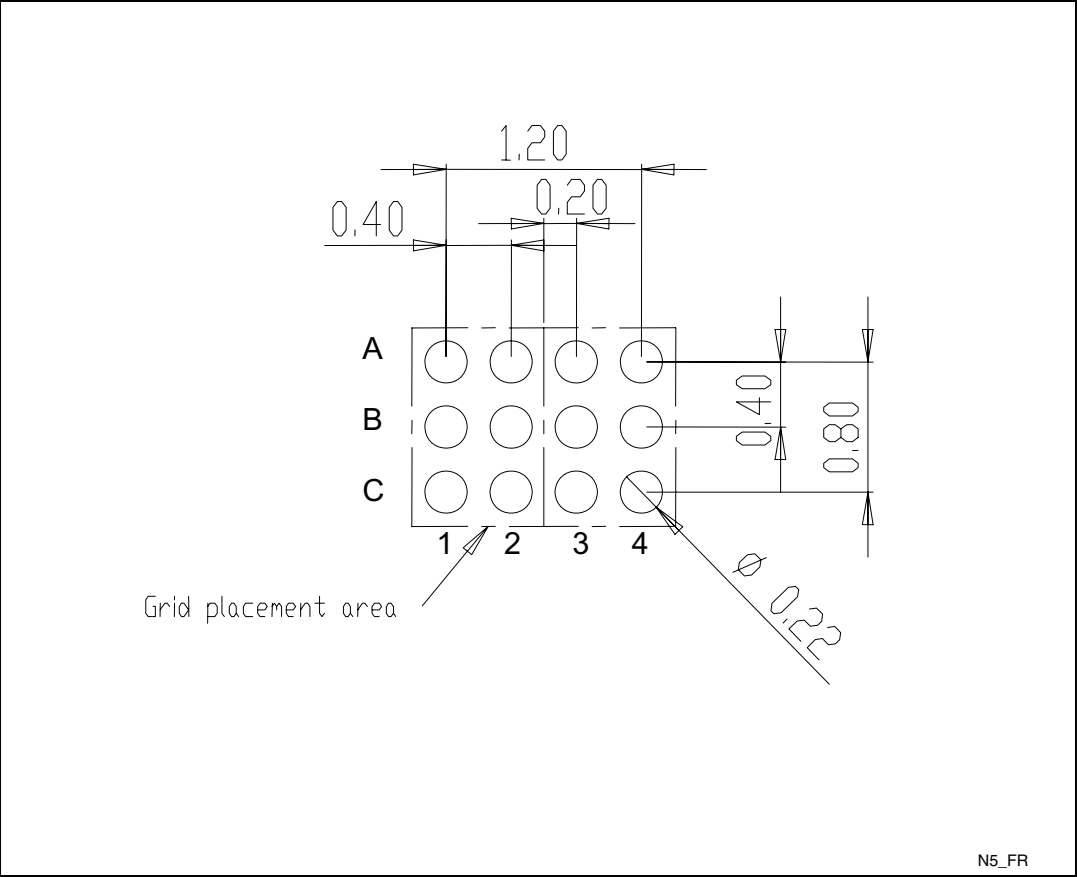


Figure 18. Tape information

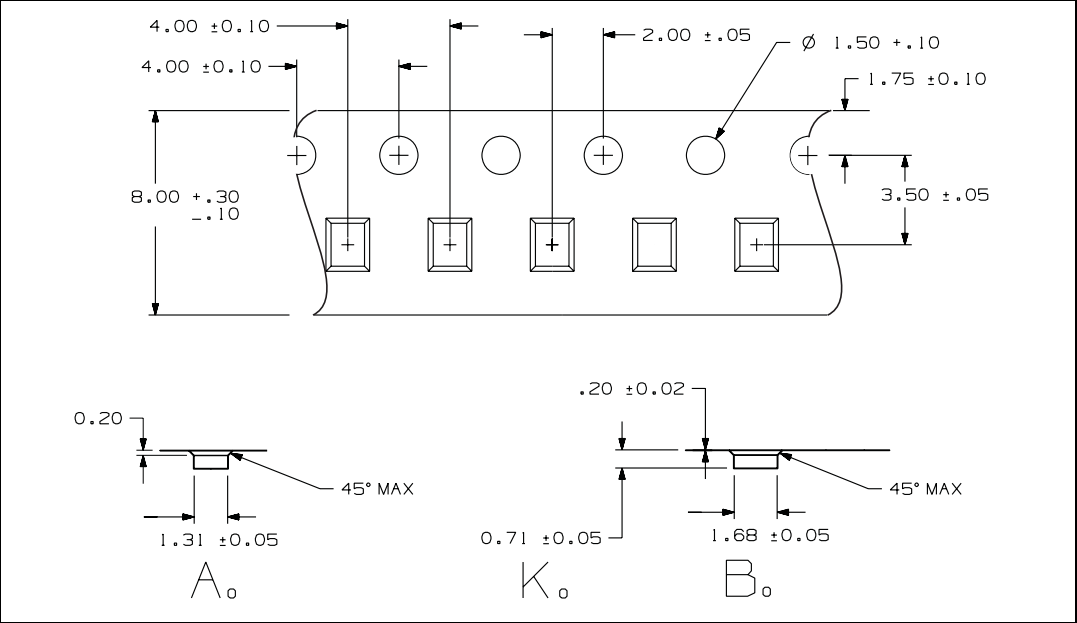


Figure 19. Tape orientation

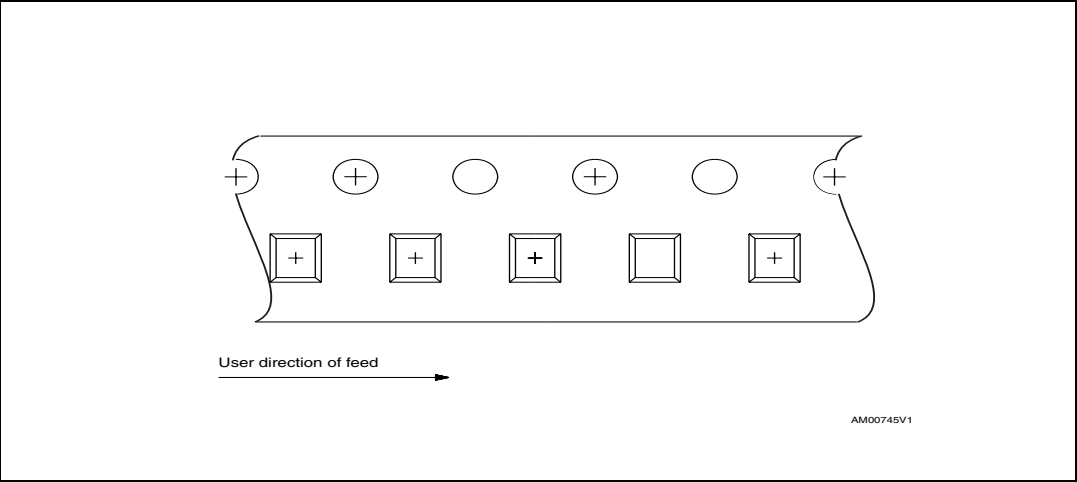
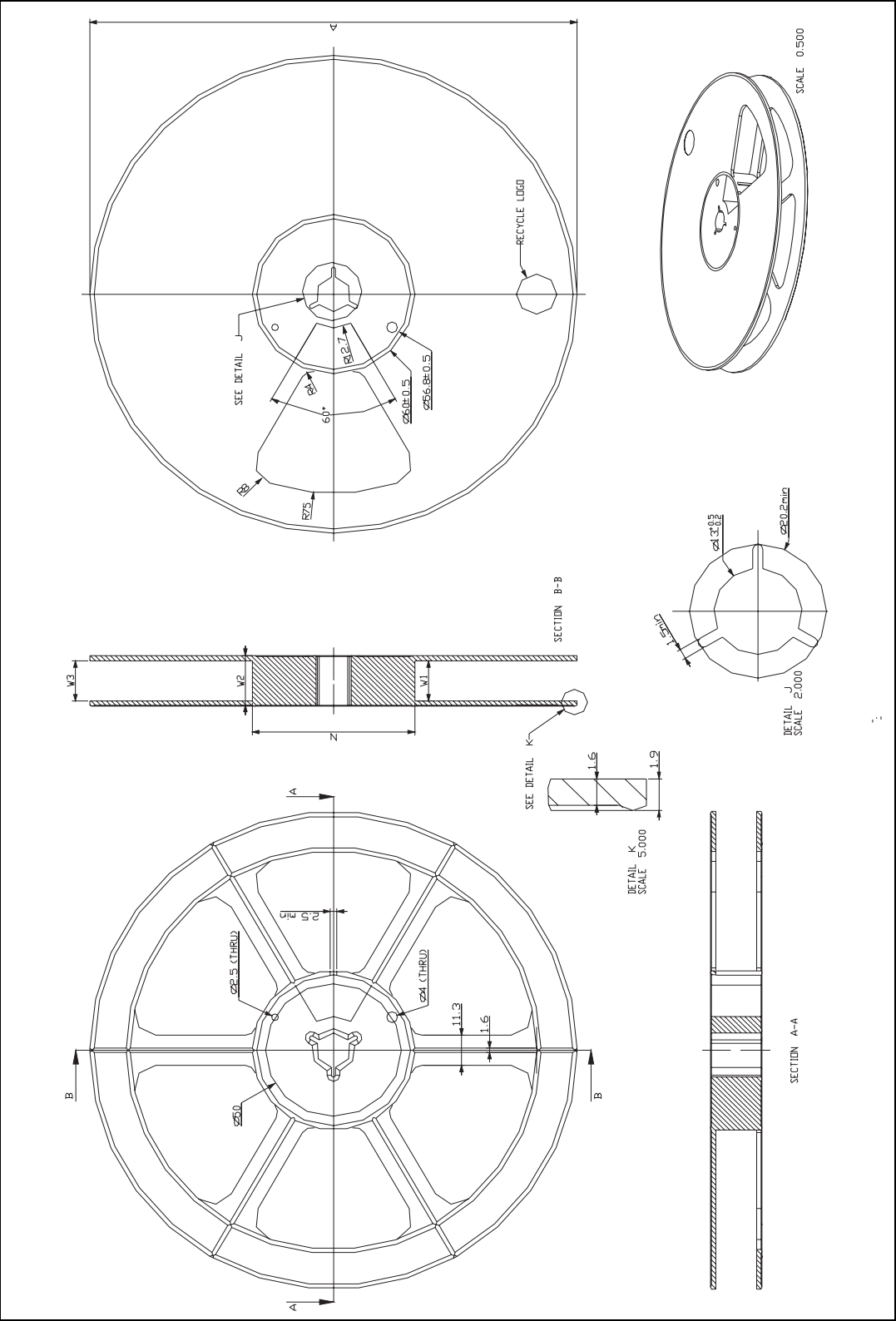


Table 11. Reel measurement

Tape width (mm)	A	N	W1		W2	W3	
	Max	Min			Max	Min	Max
8	180	54	8.4	+1.5/-0	14.4	7.9	10.9

Figure 20. Reel information



## 8 Revision history

**Table 12. Document revision history**

Date	Revision	Changes
01-Apr-2008	1	Initial release.
10-Sep-2008	2	Document status promoted from preliminary data to datasheet. Modified: <a href="#">Figure 19 on page 20</a> . Updated: <a href="#">Table 9 on page 17</a> .
04-Jun-2010	3	Added: Flip-chip 12 with back side coating. Document reformatted.

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